

CKC33C183KDGACTU

Aliases (CKC33C183KDGAC7800)

KC-LINK Comm COG, Ceramic, 0.018 uF, 10%, 1000 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 3640



Click [here](#) for the 3D model.

Dimensions	
Chip Size	3640
L	9.3mm +/-0.6mm
W	10.2mm +/-0.4mm
T	2.5mm +/-0.20mm
B	1.27mm +/-0.4mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	250

General Information	
Series	KC-LINK Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	1.06 g
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.018 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1200 VDC
Temperature Range	-55/+150°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	55.5556 GOhms

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